



NS50T07Y1M7

650 V, 50 A Three-phase Full-bridge IGBT Power Module

Rev. 1 — 8 July 2026

Product data sheet

1. General Description

The NS50T07Y1M7 is an insulated-gate bipolar transistor (IGBT) power module. The module uses 7th-generation carrier stored trench-gate and field-stop (FS) technology. It is designed for high-voltage industrial applications, including power inverters and motor drives.

2. Features

- Three-phase full-bridge topology with an NTC temperature sensor
- Rated voltage and current: 650 V/50 A
- Maximum junction temperature: 175 °C
- Short-circuit withstand time: 5 µs
- Solderable auxiliary contacts
- Optimized design for low parasitic inductance
- Low collector-emitter saturation voltage
- Low switching losses
- Validated with enhanced 2,000-hour HTRB and HV-H3TRB qualification testing

3. Applications

- Motor drives
- Servo drives
- Air conditioning systems
- Renewable energy systems
- Uninterruptible power supply (UPS) inverters

4. Quick Reference Data

Table 1. Quick Reference Data

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CES}	collector-emitter voltage	$T_{vj} = 25\text{ °C}$	-	650	V
I_{CDC}	continuous DC collector current	$T_c = 90\text{ °C}$	-	56	A
		$T_c = 100\text{ °C}$	-	51	A
$T_{vj(op)}$	operating junction temperature		-40	175	°C

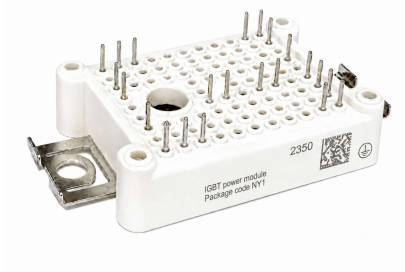


Fig. 1. Product Outline

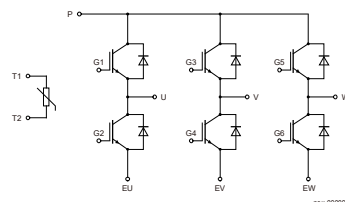


Fig. 2. Topology

5. Characteristic

5.1. IGBT

Table 2. Maximum Limiting Values

All values at $T_{vj} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CES}	collector-emitter voltage		-	650	V
I_{CDC}	continuous DC collector current[1]	$T_c = 90\text{ }^{\circ}\text{C}$	-	56	A
		$T_c = 100\text{ }^{\circ}\text{C}$	-	51	A
I_{CRM}	repetitive peak collector current[2]		-	100	A
V_{GE}	gate-emitter voltage		-20	20	V
$T_{vj(op)}$	operating junction temperature		-40	175	$^{\circ}\text{C}$

[1] Value is given at chip level, and is limited by $T_{vj(max)}$.
[2] Time duration is limited by $T_{vj(max)}$.

Table 3. Electrical Characteristics

All values at $T_{vj} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
$V_{CE(sat)}$	collector-emitter saturation voltage[1]	$V_{GE} = 15\text{ V}; I_C = 50\text{ A}$	-	1.32	1.62	V
		$V_{GE} = 15\text{ V}; I_C = 50\text{ A}; T_{vj} = 125\text{ }^{\circ}\text{C}$	-	1.48	-	V
		$V_{GE} = 15\text{ V}; I_C = 50\text{ A}; T_{vj} = 175\text{ }^{\circ}\text{C}$	-	1.56	-	V
$V_{GE(th)}$	gate-emitter threshold voltage	$I_C = 0.5\text{ mA}; V_{CE} = V_{GE}$	4.35	5.0	5.65	V
I_{CES}	zero gate voltage collector current	$V_{CE} = 650\text{ V}; V_{GE} = 0\text{ V}$	-	-	100	μA
I_{GES}	gate-emitter leakage current	$V_{CE} = 0\text{ V}; V_{GE} = 20\text{ V}$	-	-	100	nA
r_g	internal gate resistor		-	0	-	Ω
C_{ies}	input capacitance	$V_{CE} = 25\text{ V}; V_{GE} = 0\text{ V}; f = 100\text{ kHz}$	-	3.11	-	nF
C_{oes}	output capacitance		-	0.17	-	nF
C_{res}	reverse transfer capacitance		-	0.04	-	nF
Q_G	gate charge	$V_{CC} = 400\text{ V}; I_C = 50\text{ A}; V_{GE} = 15\text{ V}$	-	0.49	-	μC

[1] Value is given at chip level.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Switching Characteristics							
t _{d(on)}	turn-on delay time	V _{GE} = ± 15 V; V _{CC} = 400 V; I _C = 50 A; R _{G(on)} = 5.0 Ω R _{G(off)} = 36 Ω; di/dt = 1590 A/μs (only at turn-on, T _{vj} = 175 °C) dv/dt = 3690 V/μs (only at turn-off, T _{vj} = 175 °C)	T _{vj} = 25 °C	-	23	-	ns
			T _{vj} = 125 °C	-	26	-	ns
			T _{vj} = 175 °C	-	27	-	ns
t _r	rise time		T _{vj} = 25 °C	-	23	-	ns
			T _{vj} = 125 °C	-	26	-	ns
			T _{vj} = 175 °C	-	28	-	ns
t _{d(off)}	turn-off delay time		T _{vj} = 25 °C	-	444	-	ns
			T _{vj} = 125 °C	-	474	-	ns
			T _{vj} = 175 °C	-	494	-	ns
t _f	fall time		T _{vj} = 25 °C	-	23	-	ns
			T _{vj} = 125 °C	-	23	-	ns
			T _{vj} = 175 °C	-	26	-	ns
E _{on}	turn-on switching energy loss		T _{vj} = 25 °C	-	958	-	μJ
			T _{vj} = 125 °C	-	1296	-	μJ
			T _{vj} = 175 °C	-	1430	-	μJ
E _{off}	turn-off switching energy loss		T _{vj} = 25 °C	-	1248	-	μJ
			T _{vj} = 125 °C	-	1464	-	μJ
			T _{vj} = 175 °C	-	1585	-	μJ
I _{C(sc)}	short-circuit current[1]	V _{GE} = ±15 V; V _{CEmax} = V _{CES} - L _{sCE} * di/dt	V _{CC} = 330 V; t _p ≤ 5 μs; T _{vj} = 100 °C	-	266	-	A
			V _{CC} = 400 V; t _p ≤ 3 μs; T _{vj} = 150 °C	-	251	-	A
Thermal Resistance							
R _{th(j-c)}	thermal resistance from junction to case	per IGBT switch		-	-	0.752	K/W
R _{th(c-h)}	thermal resistance from case to heatsink	per IGBT switch; λ _{grease} = 3 W/(m·K)		-	0.577	-	K/W

[1] Short-circuit cycles ≤ 1000. Time between tests ≥ 10 s.

5.2. Diode

Table 4. Maximum Limiting Values
All values at T_{vj} = 25 °C, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
V _{RRM}	repetitive peak reverse voltage		-	650	V
I _F	continuous DC forward current[1]		-	50	A
I _{FRM}	repetitive peak forward current[2]		-	100	A
I ² t	I ² t value	V _R = 0 V; t _p = 10 ms; T _{vj} = 175 °C	-	134	A ² s
T _{vj(op)}	operating junction temperature		-40	175	°C

[1] Value is given at chip level.
[2] Time duration is limited by T_{vj(max)}.

Table 5. Electrical Characteristics

All values at $T_{vj} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V _F	diode forward voltage[1]	V _{GE} = 0 V; I _F = 50 A	T _{vj} = 25 °C	-	1.69	2.04	V
			T _{vj} = 125 °C	-	1.63	-	V
			T _{vj} = 175 °C	-	1.58	-	V
t _{rr}	reverse recovery time	V _R = 400 V; I _F = 50 A; di _F /dt = 1590 A/μs (only at T _{vj} = 175 °C)	T _{vj} = 25 °C	-	52	-	ns
			T _{vj} = 125 °C	-	76	-	ns
			T _{vj} = 175 °C	-	89	-	ns
Q _{rr}	reverse recovery charge		T _{vj} = 25 °C	-	1.39	-	μC
			T _{vj} = 125 °C	-	2.38	-	μC
			T _{vj} = 175 °C	-	3.06	-	μC
I _{rrm}	peak reverse recovery current		T _{vj} = 25 °C	-	49	-	A
			T _{vj} = 125 °C	-	61	-	A
			T _{vj} = 175 °C	-	68	-	A
E _{rec}	reverse recovery energy loss		T _{vj} = 25 °C	-	382	-	μJ
			T _{vj} = 125 °C	-	700	-	μJ
			T _{vj} = 175 °C	-	870	-	μJ
R _{th(j-c)}	thermal resistance from junction to case	per diode switch		-	-	1.095	K/W
R _{th(c-h)}	thermal resistance from case to heatsink	per diode switch; λ _{grease} = 3 W/(m·K)		-	0.701	-	K/W

[1] Value is given at chip level.

5.3. NTC Thermistor

Table 6. NTC Thermistor

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
R_{25}	rated resistance	$T_{NTC} = 25\text{ }^{\circ}\text{C}$	-	5	-	k Ω
$\Delta R/R$	deviation of R_{100}	$T_{NTC} = 100\text{ }^{\circ}\text{C}; R_{100} = 491$	-5.5	-	5.5	%
P_{25}	power dissipation	$T_{NTC} = 25\text{ }^{\circ}\text{C}$	-	-	20	mW
$B_{25/50}$	B-value		-	3375	-	K
$B_{25/80}$	B-value		-	3425	-	K
$B_{25/100}$	B-value		-	3443	-	K

5.4. Package

Table 7. Mechanical Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
RTI	relative thermal index (electrical)	housing only	-	130	-	$^{\circ}\text{C}$
L_{sCE}	internal stray inductance		-	20	-	nH
$R_{CC'+EE'}$	lead resistance, terminal to chip	$T_c = 25\text{ }^{\circ}\text{C}$, per switch	-	4.4	-	m Ω
G	weight		-	22	-	g
T_{stg}	storage temperature		-40	-	125	$^{\circ}\text{C}$
F	mounting force per clamp		20	-	50	N

Table 8. Insulation

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V _{ISOL}	isolation test voltage	RMS; f = 50 Hz; t = 1 min	-	2.5	-	kV
	material of substrate isolation		-	Al ₂ O ₃	-	-
	creepage distance	terminal to heatsink	-	14	-	mm
		terminal to terminal	-	6.5	-	mm
	clearance distance	terminal to heatsink	-	10.0	-	mm
		terminal to terminal	-	5.2	-	mm
CTI	comparative tracking index		200	-	-	

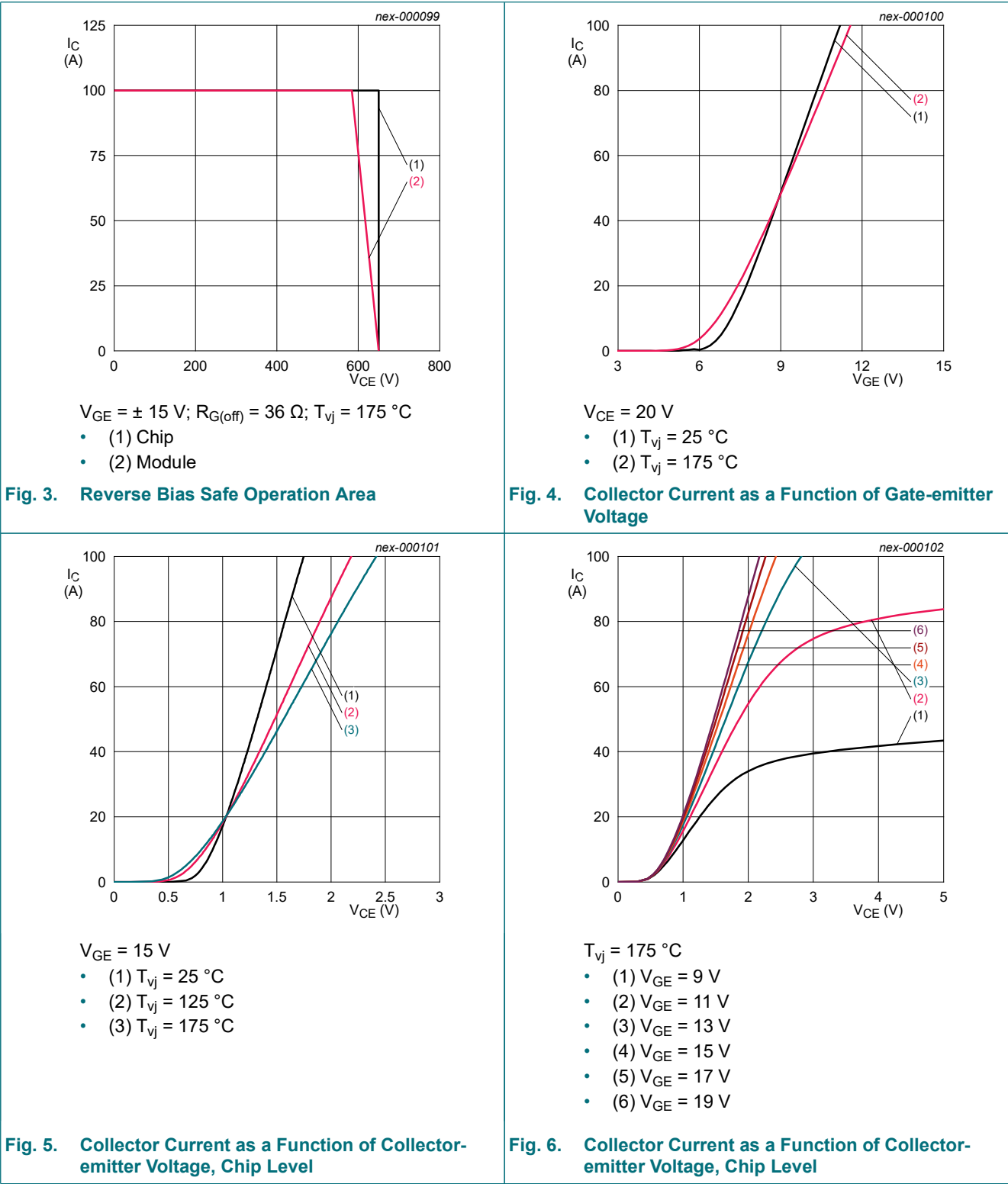
6. Ordering Information

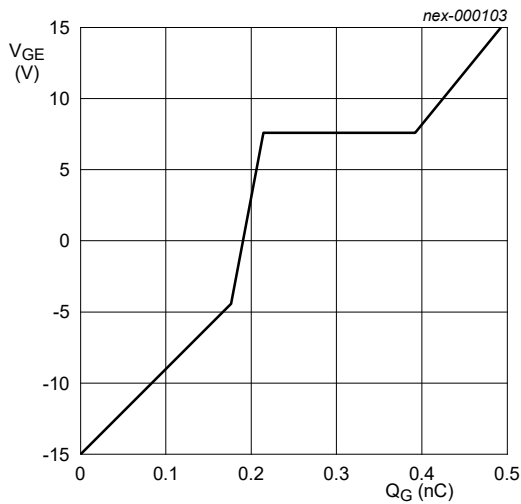
Table 9. Ordering information

Type number	Package		
	Name	Description	Version
NS50T07Y1M7	NY1	IGBT power module with three-phase full-bridge circuit topology; Solderable auxiliary contacts; Outline dimension 62.8 mm × 33.8 mm × 15.5 mm	SOT8130-2

7. Characteristic Diagram

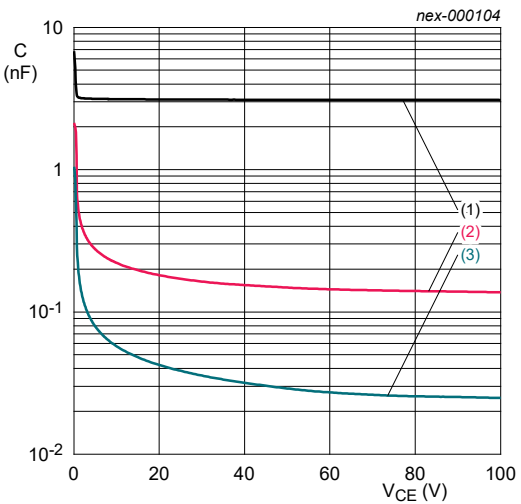
Table 10. Waveforms and Output Characteristics





$I_C = 50\text{ A}$; $V_{CE} = 400\text{ V}$

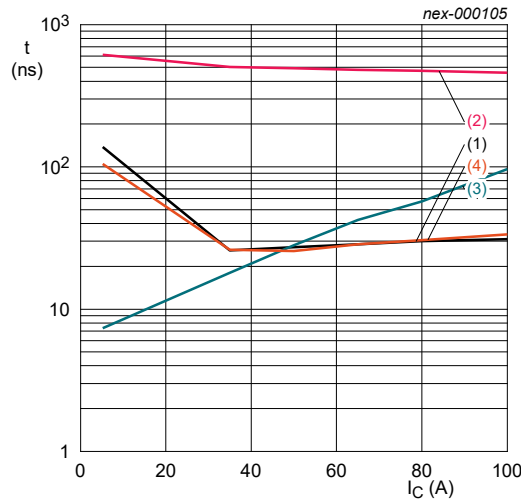
Fig. 7. Gate-emitter Voltage as a Function of Gate Charge



$V_{GE} = 0\text{ V}$; $f = 100\text{ kHz}$

- (1) C_{ies}
- (2) C_{oes}
- (3) C_{res}

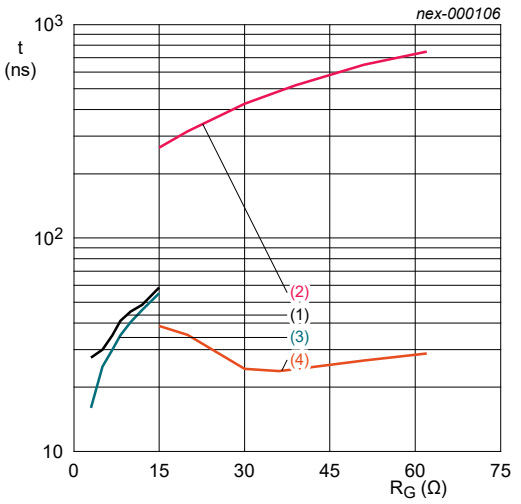
Fig. 8. Typical Capacitance as a Function of Collector-emitter Voltage



$V_{GE} = \pm 15\text{ V}$; $V_{CC} = 400\text{ V}$; $T_{vj} = 175\text{ }^\circ\text{C}$;
 $R_{G(on)} = 5\text{ }\Omega$; $R_{G(off)} = 36\text{ }\Omega$

- (1) $t_{d(on)}$
- (2) $t_{d(off)}$
- (3) t_r
- (4) t_{ff}

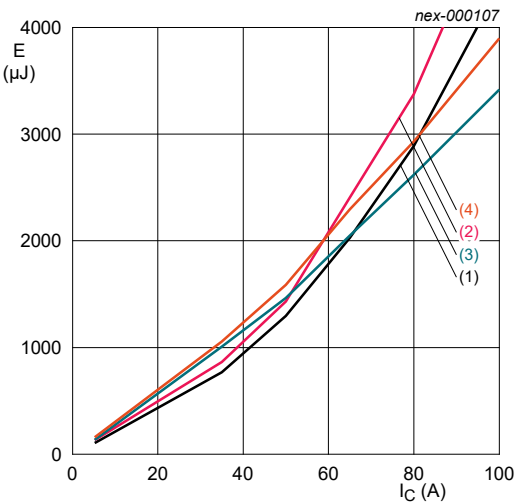
Fig. 9. Typical Switching Times as a Function of Collector Current



$V_{GE} = \pm 15\text{ V}$; $V_{CC} = 400\text{ V}$; $I_C = 50\text{ A}$; $T_{vj} = 175\text{ }^\circ\text{C}$

- (1) $t_{d(on)}$
- (2) $t_{d(off)}$
- (3) t_r
- (4) t_{ff}

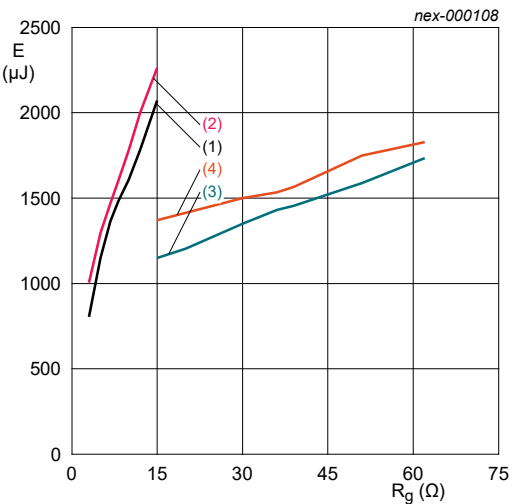
Fig. 10. Typical Switching Times as a Function of Gate Resistance



$V_{GE} = \pm 15\text{ V}; V_{CC} = 400\text{ V}$
 $R_{G(on)} = 5\text{ }\Omega; R_{G(off)} = 36\text{ }\Omega$

- (1) $E_{on}, T_{vj} = 125\text{ }^{\circ}\text{C}$
- (2) $E_{on}, T_{vj} = 175\text{ }^{\circ}\text{C}$
- (3) $E_{off}, T_{vj} = 125\text{ }^{\circ}\text{C}$
- (4) $E_{off}, T_{vj} = 175\text{ }^{\circ}\text{C}$

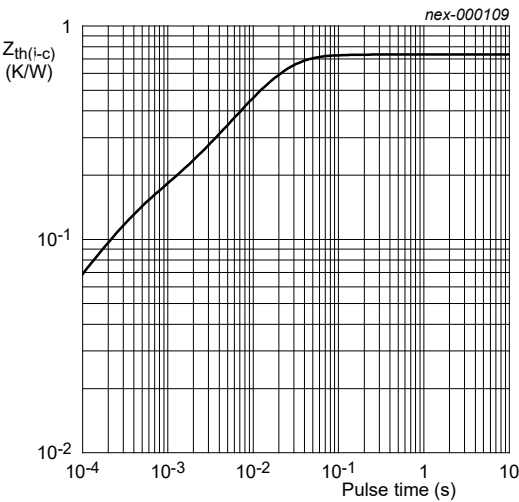
Fig. 11. Typical Switching Energy Losses as a Function of Collector Current



$V_{GE} = \pm 15\text{ V}; V_{CC} = 400\text{ V}; I_C = 50\text{ A}$

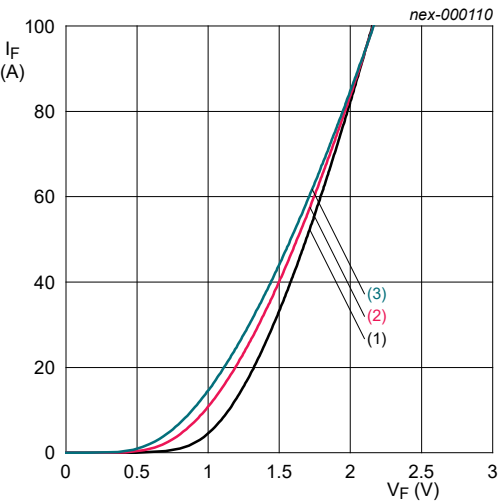
- (1) $E_{on}, T_{vj} = 125\text{ }^{\circ}\text{C}$
- (2) $E_{on}, T_{vj} = 175\text{ }^{\circ}\text{C}$
- (3) $E_{off}, T_{vj} = 125\text{ }^{\circ}\text{C}$
- (4) $E_{off}, T_{vj} = 175\text{ }^{\circ}\text{C}$

Fig. 12. Typical Switching Energy Losses as a Function of Gate Resistance



i	1	2	3	4
r_i [K/W]	0.01557	0.00760	0.11972	0.60867
τ_i [s]	0.000004	0.000029	0.000334	0.016602

Fig. 13. Transient Thermal Impedance of IGBT as a Function of Single Pulse



- (1) $T_{vj} = 25\text{ }^{\circ}\text{C}$
- (2) $T_{vj} = 125\text{ }^{\circ}\text{C}$
- (3) $T_{vj} = 175\text{ }^{\circ}\text{C}$

Fig. 14. Typical Diode Forward Current as a Function of Forward Voltage, Chip Level

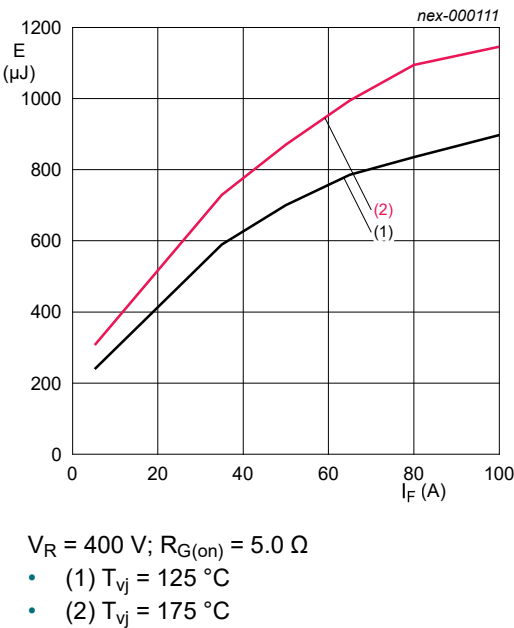


Fig. 15. Typical Reverse Recovery Energy Loss as a Function of Forward Current

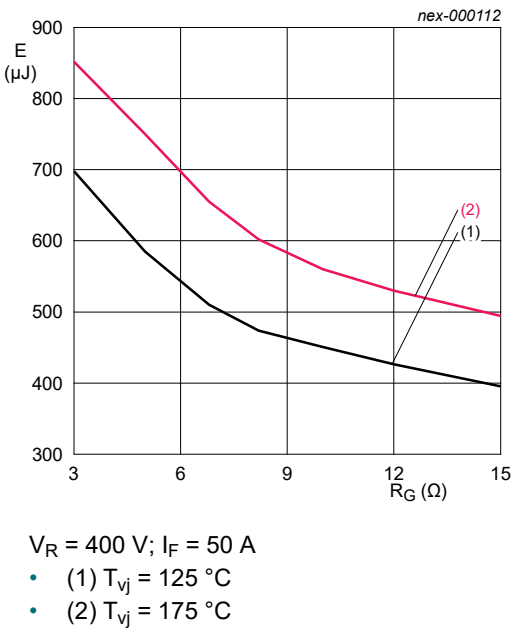
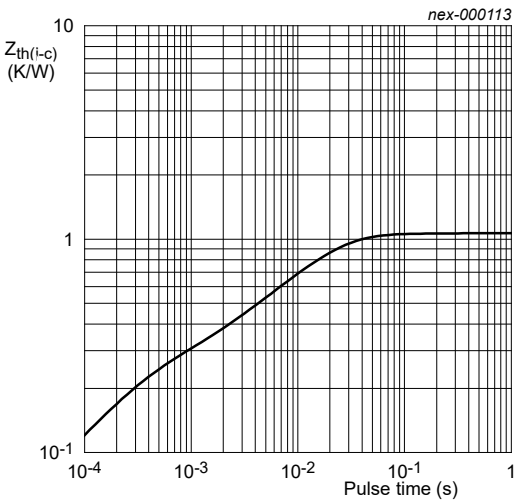


Fig. 16. Typical Reverse Recovery Energy Loss as a Function of Gate Resistance



i	1	2	3	4
r_i [K/W]	0.02522	0.00946	0.22449	0.83590
τ_i [s]	0.000003	0.000023	0.000295	0.017238

Fig. 17. Transient Thermal Impedance of Diode as a Function of Single Pulse

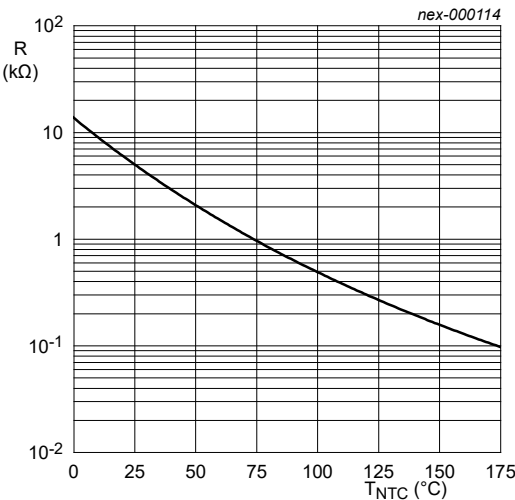


Fig. 18. NTC-thermistor Characteristics

8. Waveform Definition

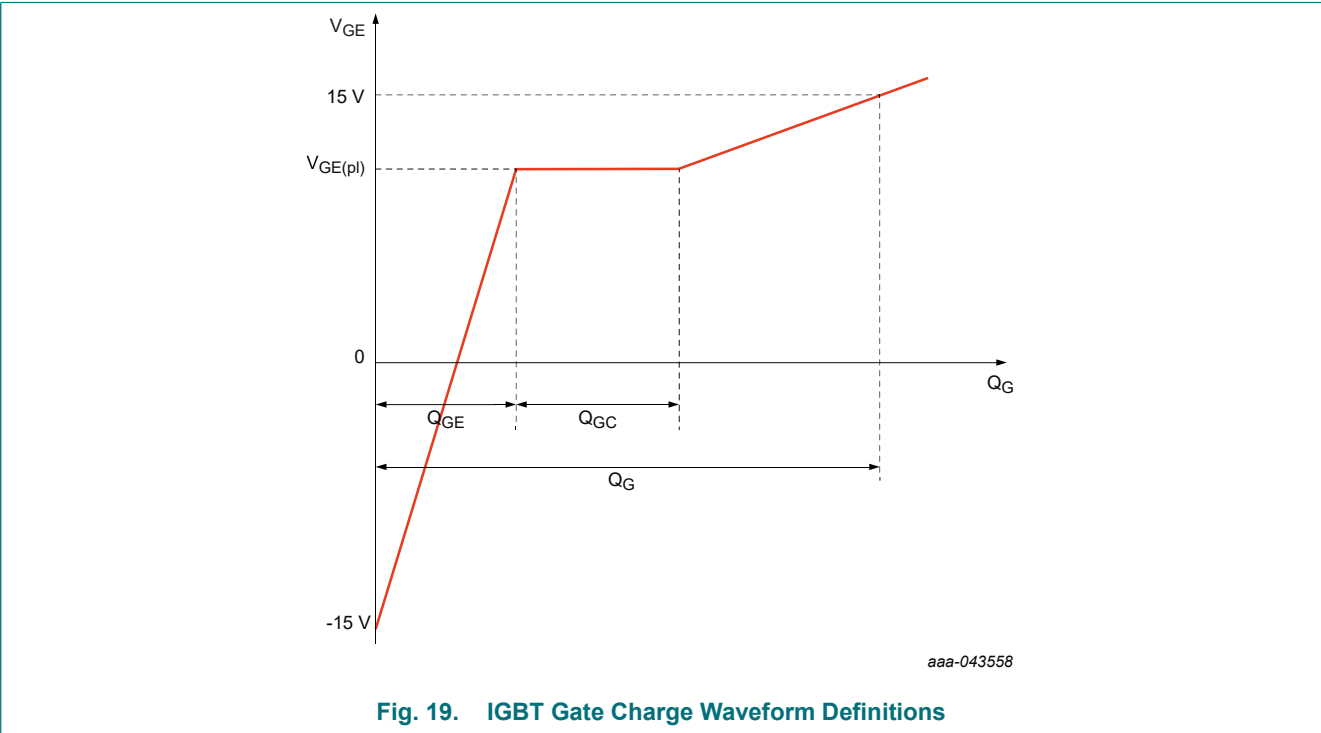


Fig. 19. IGBT Gate Charge Waveform Definitions

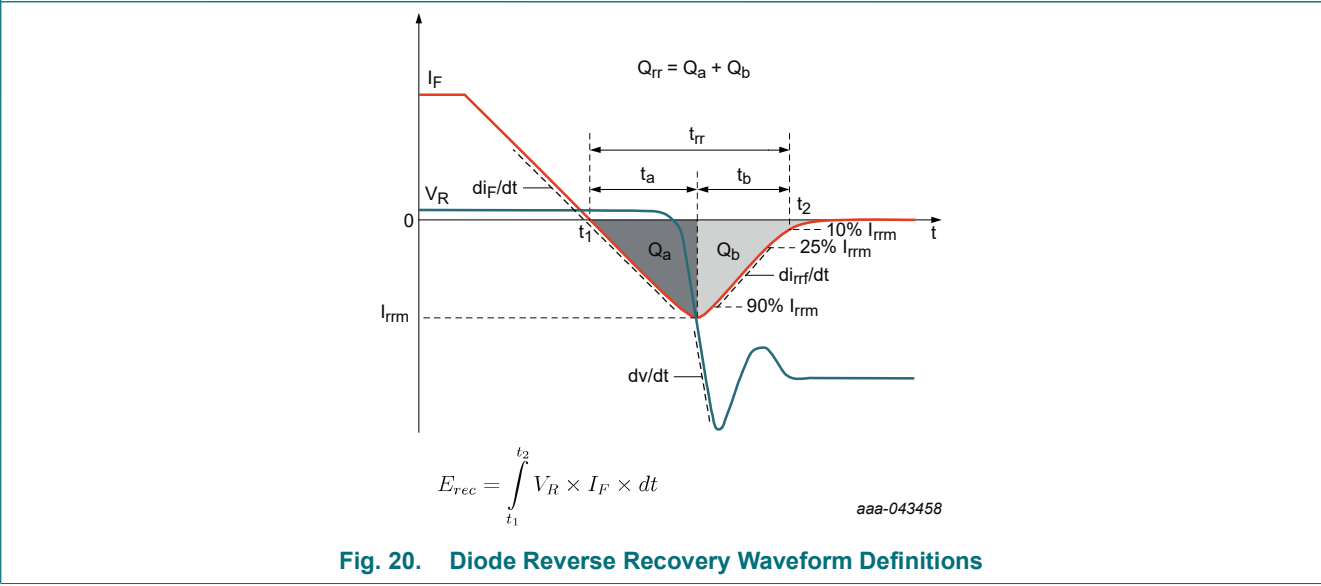
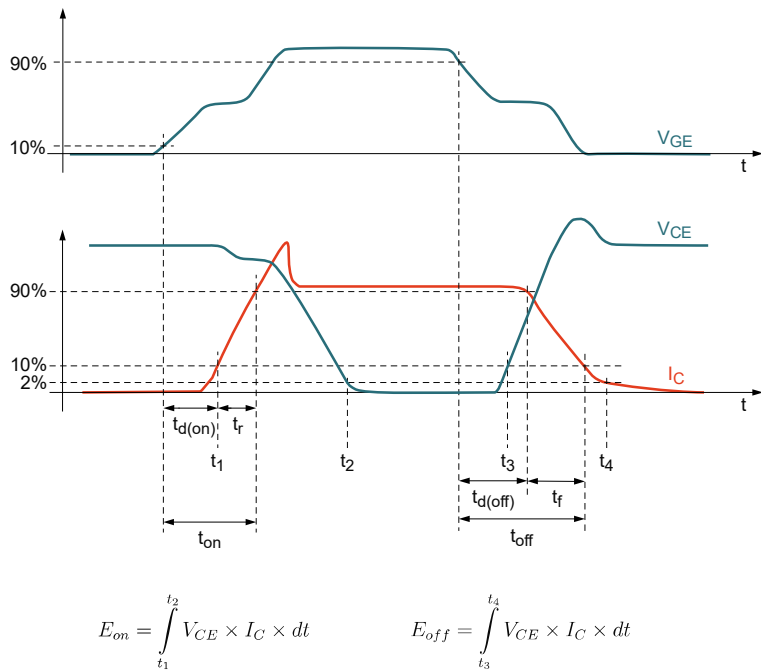


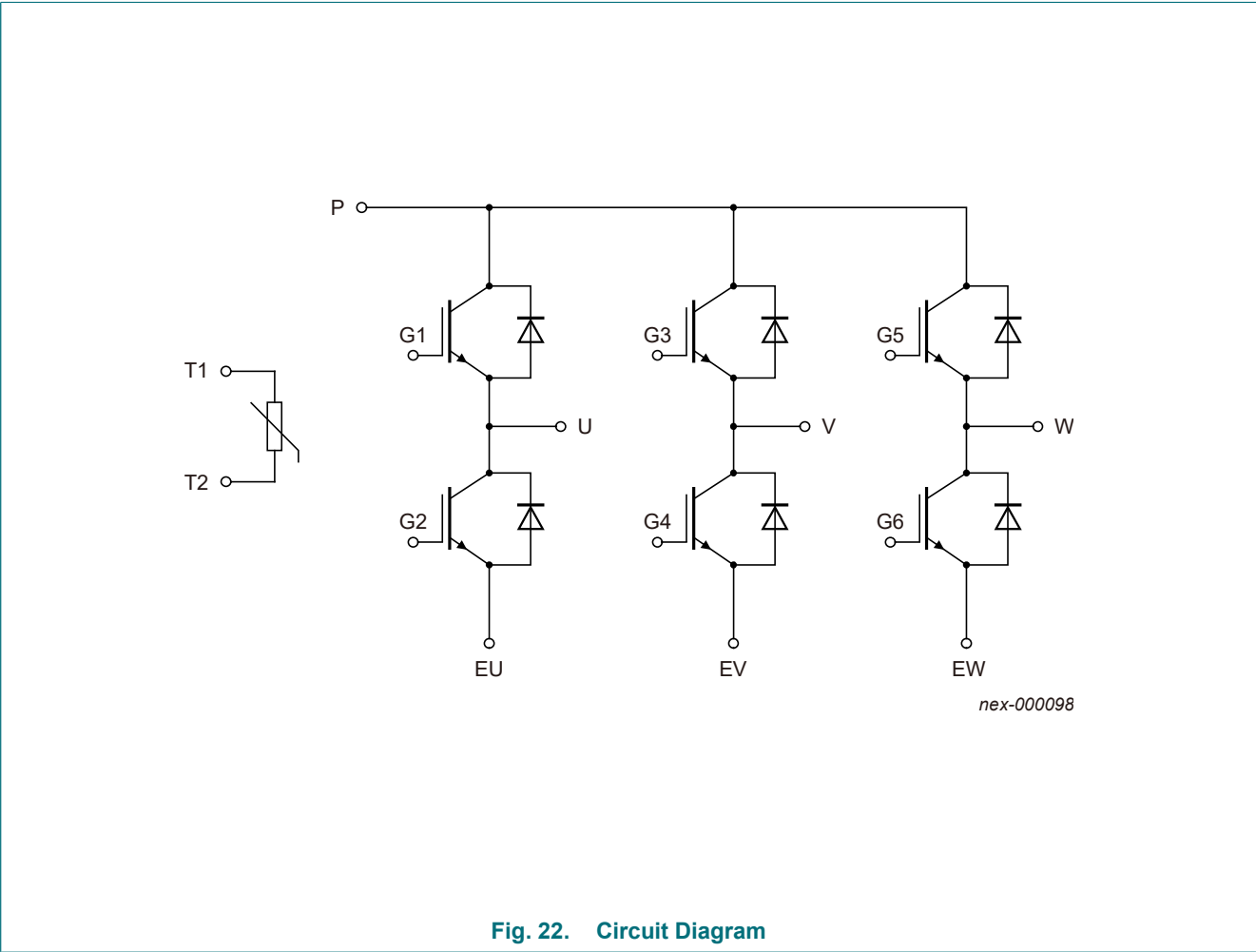
Fig. 20. Diode Reverse Recovery Waveform Definitions



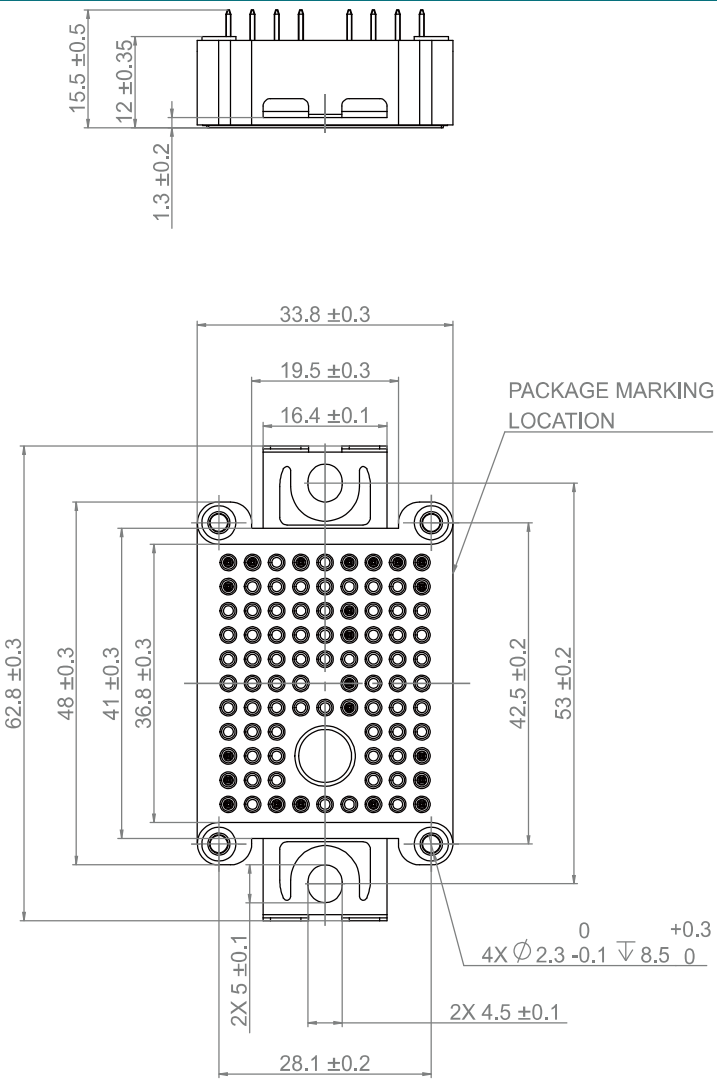
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Fig. 21. IGBT Switching Times and Energy Loss Definitions

9. Circuit Diagram

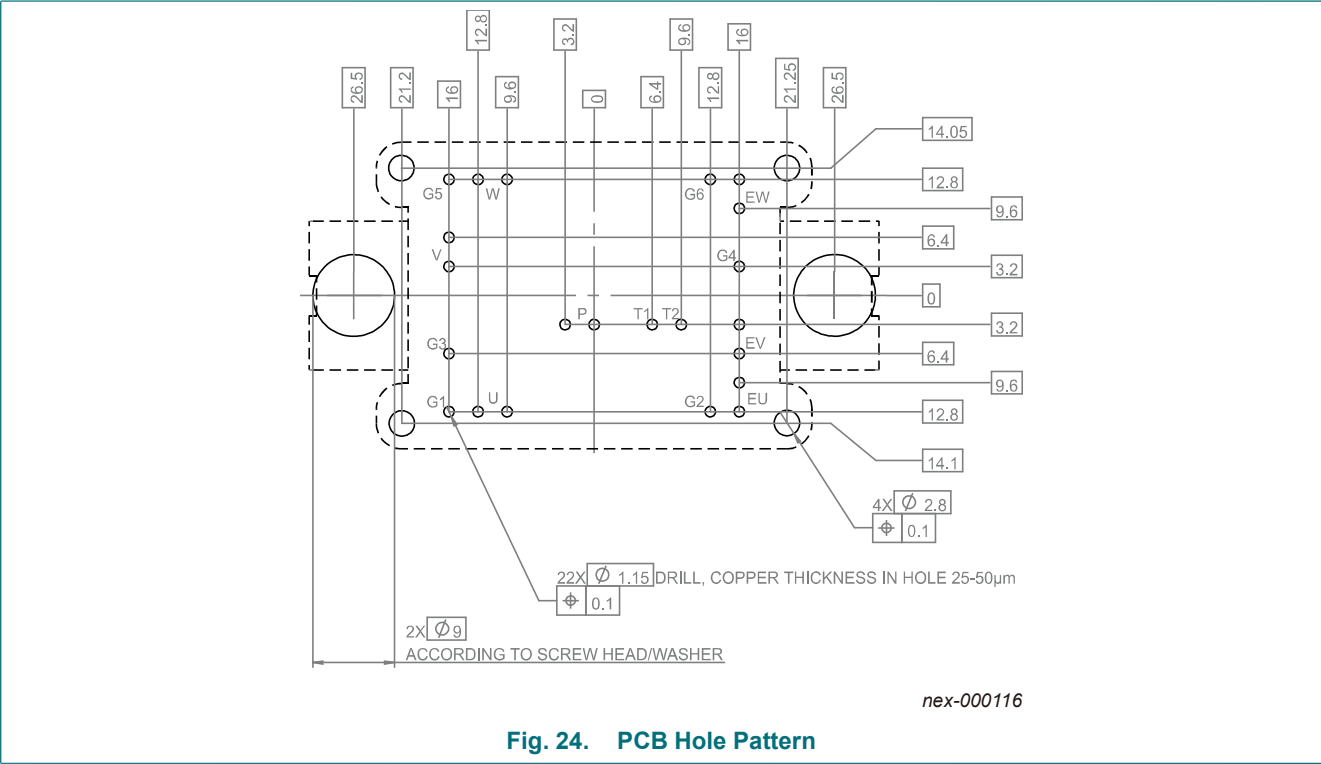


10. Package Outline



nex-000115

Fig. 23. Package Outline



11. Revision History

Table 11. Revision History

Document ID	Release Date	Data Sheet Status	Supersedes
NS50T07Y1M7 v.1	20260708	Product data sheet	-

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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